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April 2015

FDD86250

N-Channel Shielded Gate PowerTrench® MOSFET

150 V, 51 A, 22 mΩ

Features

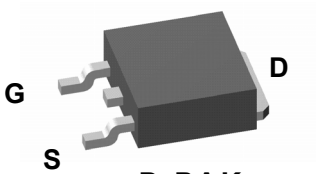
- Shielded Gate MOSFET Technology
- Max $r_{DS(on)}$ = 22 mΩ at V_{GS} = 10 V, I_D = 8 A
- Max $r_{DS(on)}$ = 31 mΩ at V_{GS} = 6 V, I_D = 6.5 A
- 100% UIL tested
- RoHS Compliant

General Description

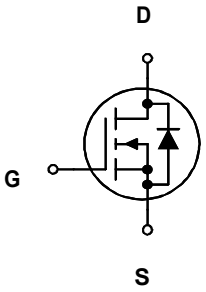
This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

Application

- DC - DC Conversion



D-PAK
(TO-252)



MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units
V_{DS}	Drain to Source Voltage			150	V
V_{GS}	Gate to Source Voltage			±20	V
I_D	Drain Current -Continuous	T_C = 25 °C	(Note 5)	51	A
	-Continuous	T_C = 100 °C	(Note 5)	27	
	-Continuous	T_A = 25 °C	(Note 1a)	8	
	-Pulsed		(Note 4)	164	
E_{AS}	Single Pulse Avalanche Energy		(Note 3)	180	mJ
P_D	Power Dissipation	T_C = 25 °C		132	W
	Power Dissipation	T_A = 25 °C	(Note 1a)	3.1	
T_J, T_{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.94	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	40	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86250	FDD86250	D-PAK(TO-252)	13 ”	16 mm	2500 units

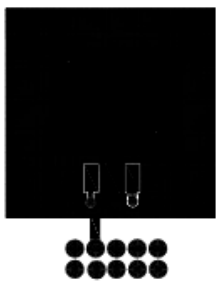
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Electrical Characteristics T_J = 25 °C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
BV_{DSS}	Drain to Source Breakdown Voltage	I_D = 250 μA, V_{GS} = 0 V	150			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μA, referenced to 25 °C		106		mV/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 120 V, V_{GS} = 0 V			1	μA
I_{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±100	nA
On Characteristics						
$V_{GS(th)}$	Gate to Source Threshold Voltage	V_{GS} = V_{DS}, I_D = 250 μA	2.0	2.9	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μA, referenced to 25 °C		-10		mV/°C
$r_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10 V, I_D = 8 A		18.4	22	mΩ
		V_{GS} = 6 V, I_D = 6.5 A		21.4	31	
		V_{GS} = 10 V, I_D = 8 A, T_J = 125 °C		35.8	45	
g_{FS}	Forward Transconductance	V_{DS} = 10 V, I_D = 8 A		28		S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 75 V, V_{GS} = 0 V, f = 1 MHz		1585	2110	pF
C_{oss}	Output Capacitance			167	225	pF
C_{rss}	Reverse Transfer Capacitance			7	15	pF
R_g	Gate Resistance			0.6		Ω
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 75 V, I_D = 8 A, V_{GS} = 10 V, R_{GEN} = 6 Ω		11.2	20	ns
t_r	Rise Time			3.7	10	ns
$t_{d(off)}$	Turn-Off Delay Time			20	32	ns
t_f	Fall Time			4	10	ns
Q_g	Total Gate Charge	V_{GS} = 0 V to 10 V; V_{DD} = 75 V, I_D = 8 A		23	33	nC
Q_g	Total Gate Charge	V_{GS} = 0 V to 5 V; V_{DD} = 75 V, I_D = 8 A		12.8	18	nC
Q_{gs}	Gate to Source Charge	V_{DD} = 75 V, I_D = 8 A		6.7		nC
Q_{gd}	Gate to Drain “Miller” Charge	V_{DD} = 75 V, I_D = 8 A		4.7		nC
Drain-Source Diode Characteristics						
V_{SD}	Source-Drain Diode Forward Voltage	V_{GS} = 0 V, I_S = 8 A (Note 2)		0.78	1.3	V
		V_{GS} = 0 V, I_S = 2.6 A (Note 2)		0.73	1.2	
t_{rr}	Reverse Recovery Time	I_F = 8 A, di/dt = 100 A/μs		71	113	ns
Q_{rr}	Reverse Recovery Charge			104	166	nC

Notes:

1: $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta JA}$ is determined by the user's board design.



a) 40 °C/W when mounted on a 1 in^2 pad of 2 oz copper



b) 96 °C/W when mounted on a minimum pad

2: Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.
3: Starting T_J = 25 °C, L = 1.0 mH, I_{AS} = 19 A, V_{DD} = 135 V, V_{GS} = 10 V.
4: Pulsed Id please refer to Fig 11 SOA graph for more details.
5: Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

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Typical Characteristics T_J = 25 °C unless otherwise noted.

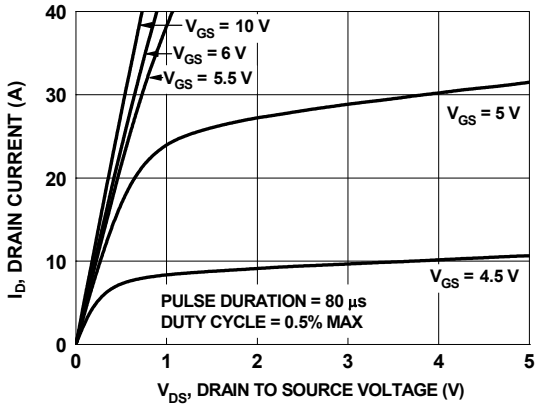


Figure 1. On-Region Characteristics

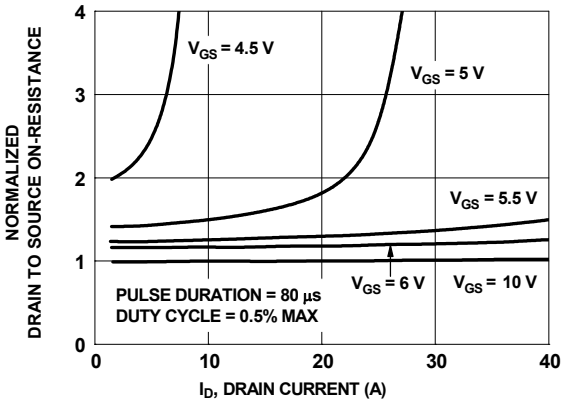


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

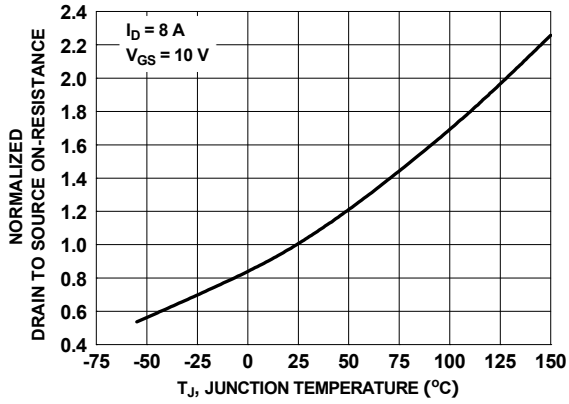


Figure 3. Normalized On-Resistance vs. Junction Temperature

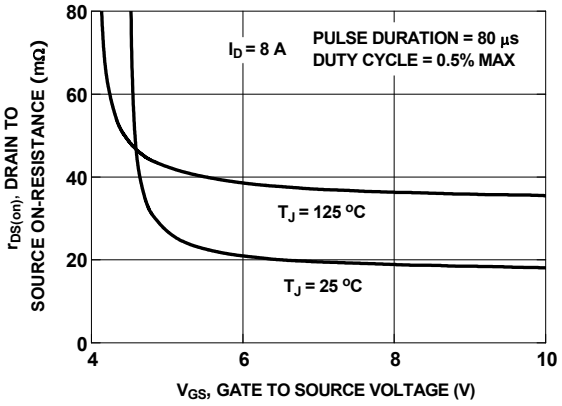


Figure 4. On-Resistance vs. Gate to Source Voltage

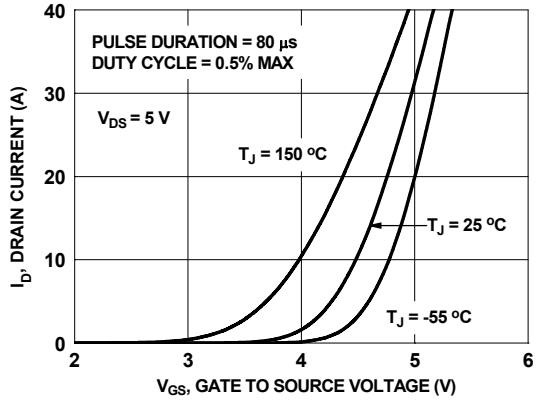


Figure 5. Transfer Characteristics

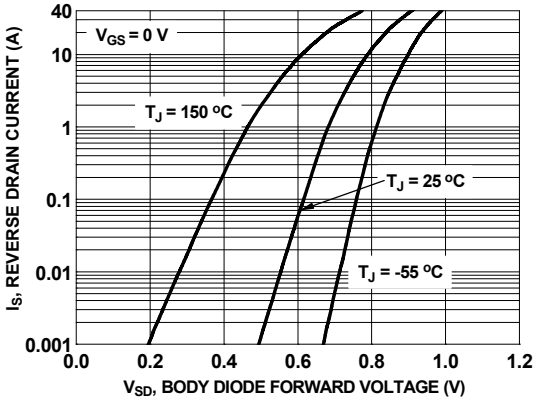


Figure 6. Source to Drain Diode Forward Voltage vs. Source Current

Typical Characteristics T_J = 25 °C unless otherwise noted.

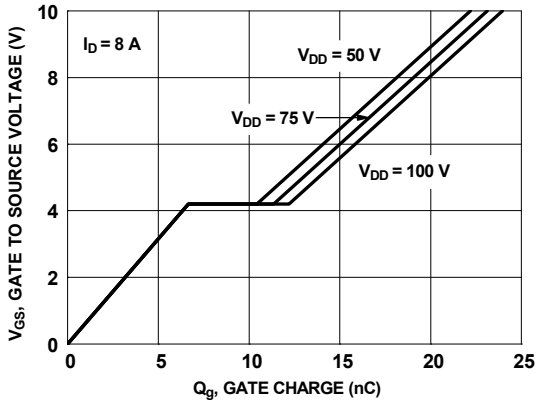


Figure 7. Gate Charge Characteristics

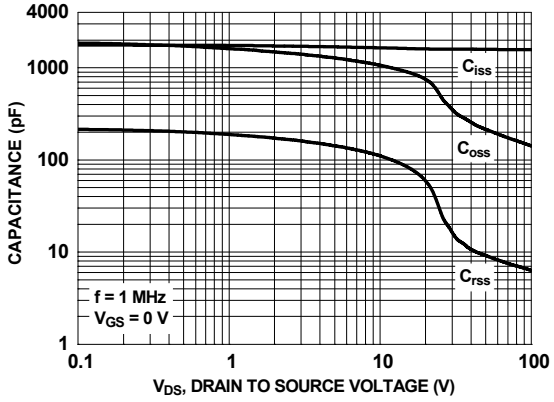


Figure 8. Capacitance vs. Drain to Source Voltage

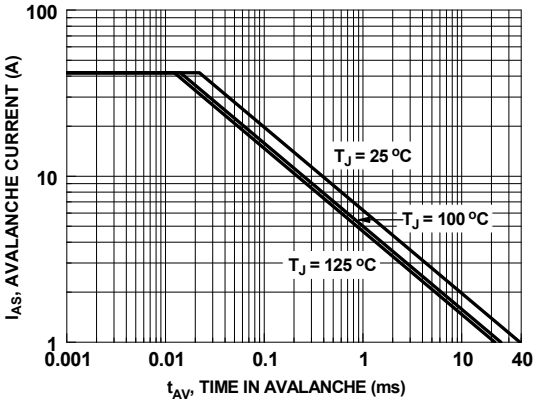


Figure 9. Unclamped Inductive Switching Capability

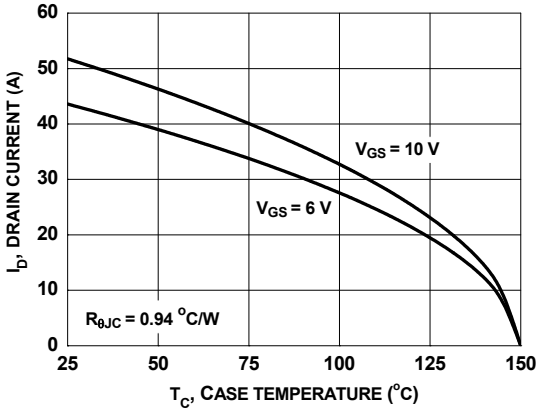


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

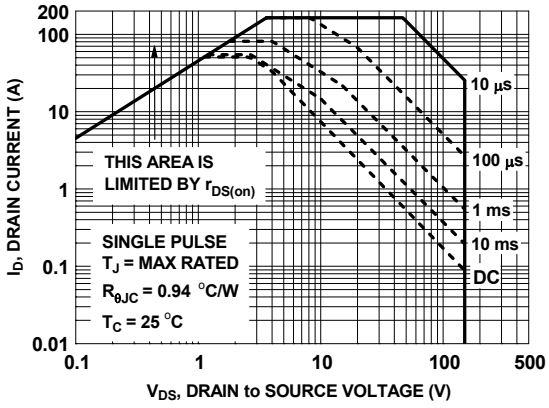


Figure 11. Forward Bias Safe Operating Area

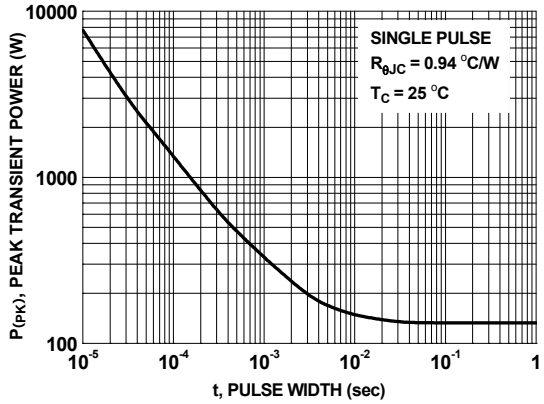


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics T_J = 25 °C unless otherwise noted.

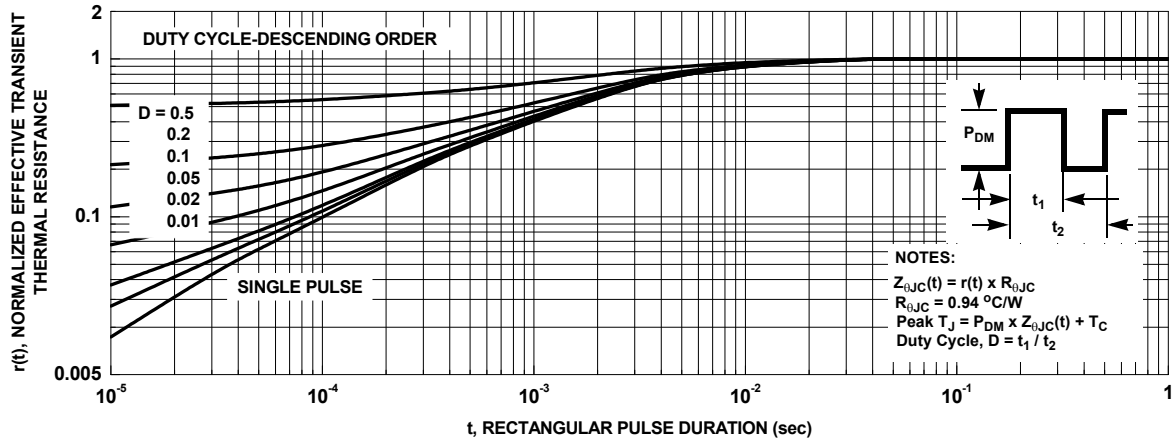
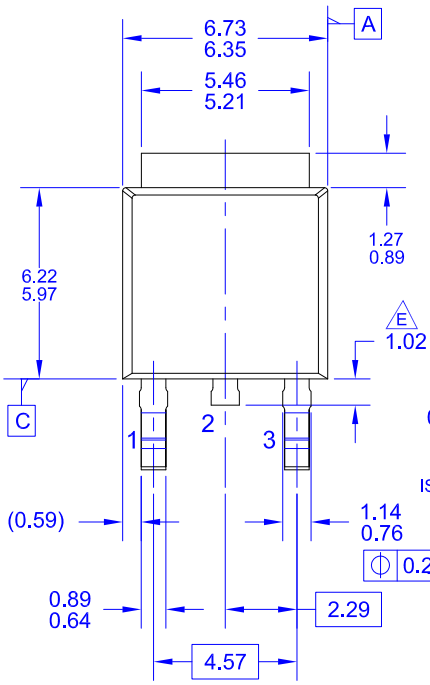
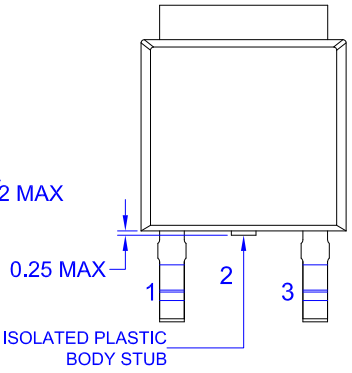


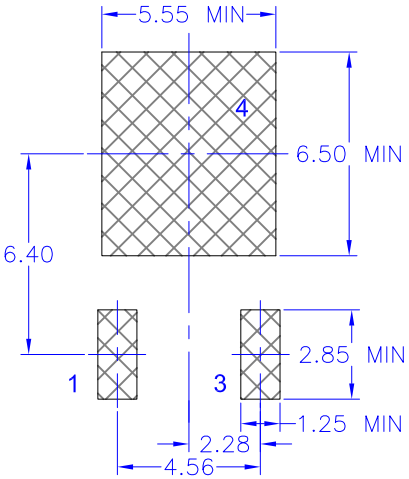
Figure 13. Junction-to-Case Transient Thermal Response Curve



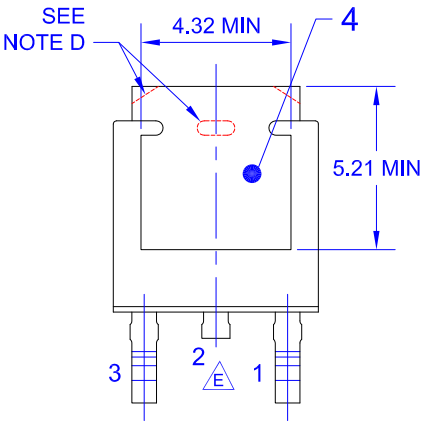
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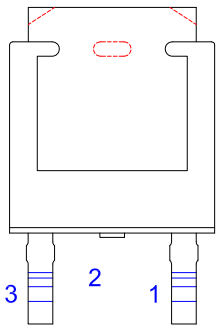
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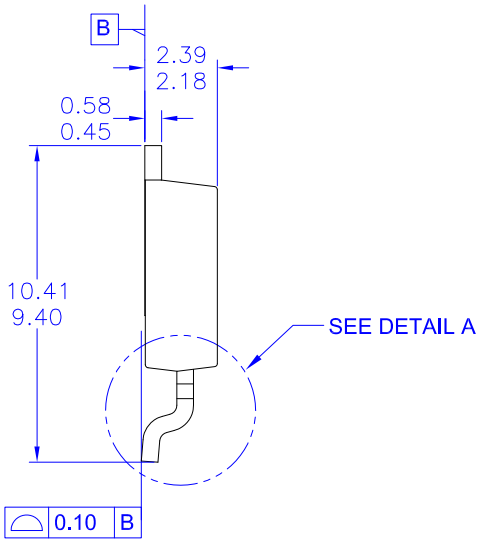
LAND PATTERN RECOMMENDATION



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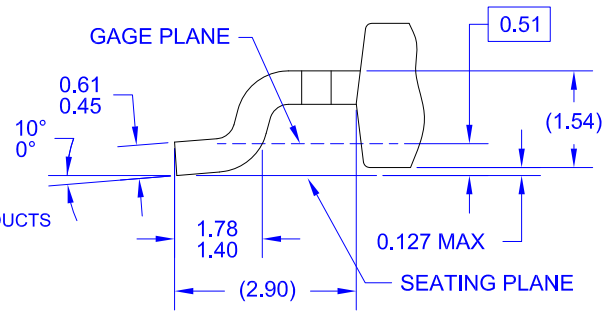


DIODE PRODUCTS VERSION



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B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
D) SUPPLIER DEPENDENT MOLD LOCKING HOLES OR CHAMFERED CORNERS OR EDGE PROTRUSION.
E) TRIMMED METAL CENTER LEAD IS PRESENT ON FOR NON-DIODE PRODUCTS
F) DIMENSIONS ARE EXCLUSIVE OF BURS, MOLD FLASH AND TIE BAR EXTRUSIONS.
G) LAND PATTERN RECOMMENDATION IS BASED ON IPC7351A STD TO228P991X239-3N.
H) DRAWING NUMBER AND REVISION: MKT-TO252A03REV11



DETAIL A
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